Low voltage variable capacitance diode

Rev. 2 — 8 September 2011

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

The BB208-02 is a planar technology variable capacitance diode in a SOD523 (SC-79) ultra small SMD plastic package.

The BB208-03 is a planar technology variable capacitance diode in a SOD323 (SC-76) very small SMD plastic package.

#### **1.2 Features and benefits**

- Very small SMD plastic packages
- Very low series resistance
- Excellent CV linearity
- C<sub>d(1V)</sub>: 21.5 pF; C<sub>d(7.5V)</sub>: 4.9 pF
- High ratio.

#### **1.3 Applications**

- Voltage Controlled Oscillators (VCO)
- Voltage Controlled Crystal Oscillators/Temperature Controlled Crystal Oscillators (VCXO/TCXO).

### 2. Pinning information

Table 1.	Discrete pinning: SOD523		
Pin	Description	Simplified outline	Symbol
1	cathode		Ш
2	anode	1 2	sym008
Table 2.	Discrete pinning: SOD323		
Pin	Description	Simplified outline	Symbol
1	cathode	<u></u>	Ш
2	anode		${\Rightarrow}$



svm008

Low voltage variable capacitance diode

# 3. Ordering information

Table 3. Ordering information					
Type number Package					
Name	Description	Version			
-	plastic surface mounted package; 2 leads	SOD523			
-	plastic surface mounted package; 2 leads	SOD323			
	Package	Package       Name     Description       -     plastic surface mounted package; 2 leads			

# 4. Marking

Table 4. Marking	
Type number	Marking code
BB208-02	A1
BB208-03	A2

### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	continuous reverse voltage		-	10	V
l <sub>F</sub>	continuous forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	operating junction temperature	)	-55	+125	°C

# 6. Characteristics

#### Table 6. Electrical characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

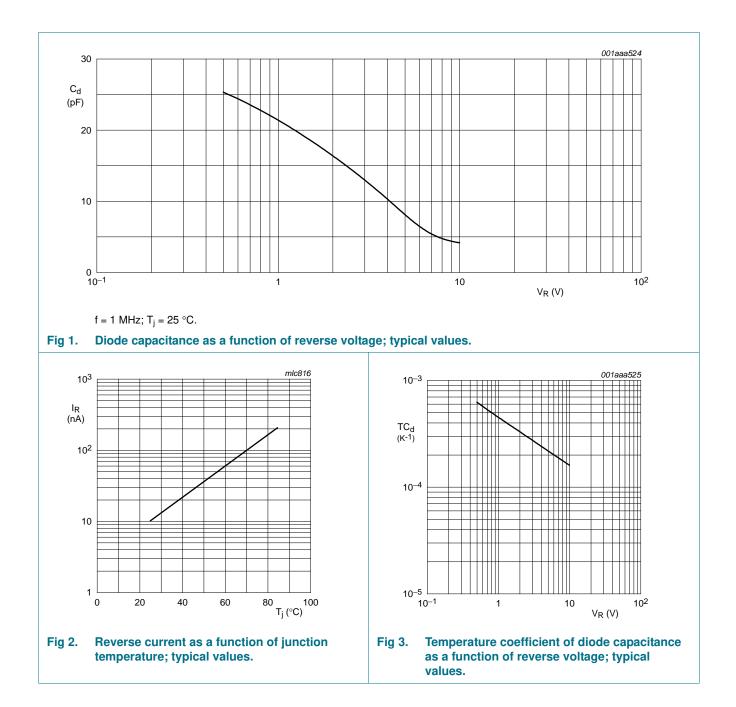
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Symbol	Farameter		IVIIII	чур	IVIAA	Unit
I <sub>R</sub>	reverse current	$V_R = 10 V$ ; see <u>Figure 2</u>	-	-	10	nA
		$V_R = 10 V; T_j = 85 \circ C; see Figure 2$	-	-	200	nA
r <sub>s</sub>	diode series resistance	f = 100 MHz; V <sub>R</sub> = 3 V	-	0.35	0.5	Ω
C <sub>d</sub> diode capacitance		f = 1 MHz; see Figure 1 and Figure 3				
		$V_{R} = 1 V$	19.9	-	23.2	pF
		$V_{R} = 4 V$	-	10.1	-	pF
		V <sub>R</sub> = 7.5 V	4.5	-	5.4	pF
$\frac{C_{d(1V)}}{2}$	capacitance ratio	f = 1 MHz	2.0	-	-	
$C_{d(4V)}$						
$C_{d(1V)}$	capacitance ratio	f = 1 MHz	3.7	-	5.2	
$C_{d(7.5V)}$						

BB208-02; BB208-03 Product data sheet

#### **NXP Semiconductors**

# BB208-02; BB208-03

Low voltage variable capacitance diode



Low voltage variable capacitance diode

### 7. Package outline

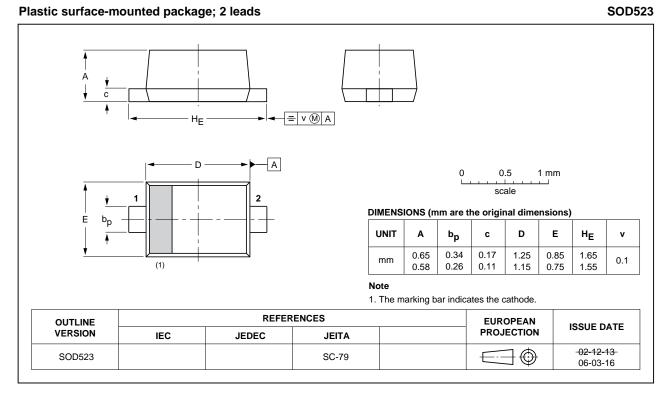
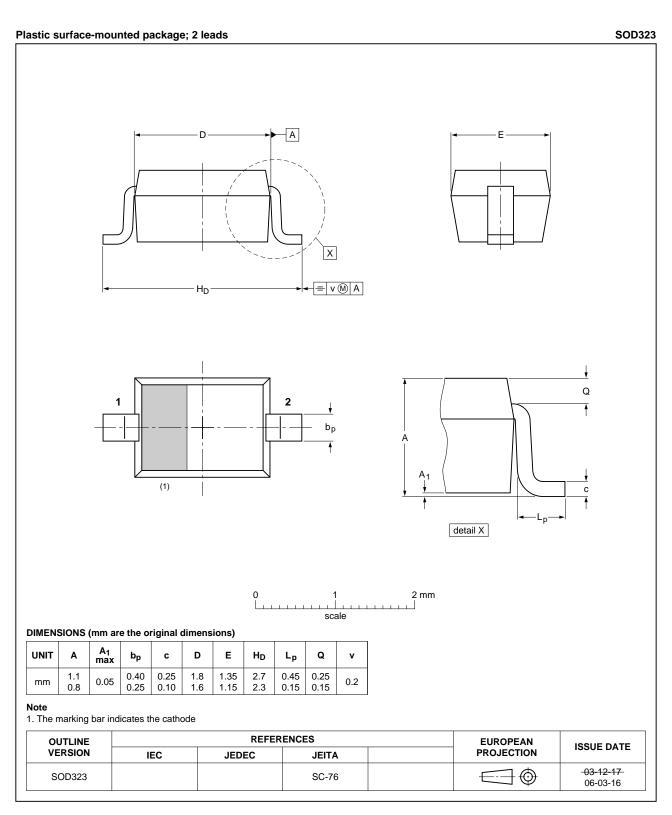


Fig 4. Package outline (BB208-02).

BB208-02; BB208-03

Low voltage variable capacitance diode



#### Fig 5. Package outline (BB208-03).

Low voltage variable capacitance diode

# 8. Revision history

Table 7. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB208-02_BB208-03 v.2	20110908	Product data sheet	-	BB208-02_BB208-03 v.1
Modifications:		of this data sheet has beer NXP Semiconductors.	n redesigned to comply w	ith the new identity
	<ul> <li>Legal texts h</li> </ul>	ave been adapted to the	new company name whe	re appropriate.
	<ul> <li>Package out</li> </ul>	line drawings have been u	updated to the latest vers	ion.
BB208-02_BB208-03 v.1 (9397 750 12696)	20040407	Product data	-	-

BB208-02; BB208-03

Low voltage variable capacitance diode

### 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 9.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 9.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

BB208-02; BB208-03

© NXP B.V. 2011. All rights reserved.

Low voltage variable capacitance diode

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

# **10. Contact information**

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

#### 9.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: <a href="mailto:salesaddresses@nxp.com">salesaddresses@nxp.com</a>

Low voltage variable capacitance diode

### 11. Contents

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Characteristics 2
7	Package outline 4
8	Revision history 6
9	Legal information 7
9.1	Data sheet status 7
9.2	Definitions7
9.3	Disclaimers
9.4	Trademarks 8
10	Contact information 8
11	Contents 9

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 8 September 2011 Document identifier: BB208-02; BB208-03